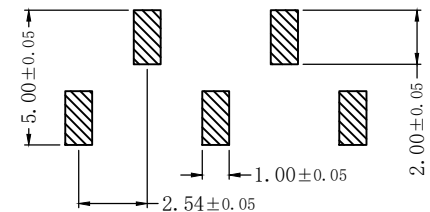
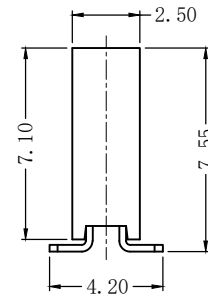
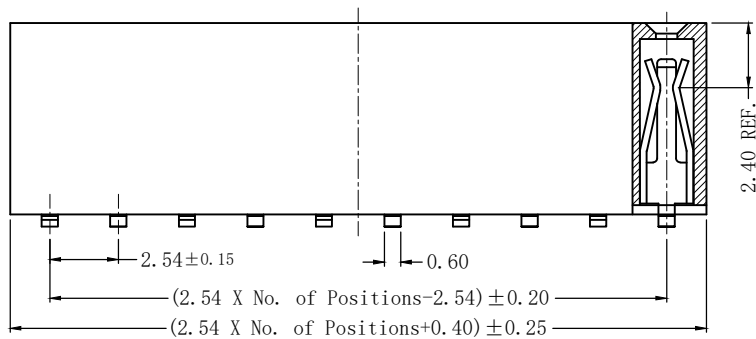
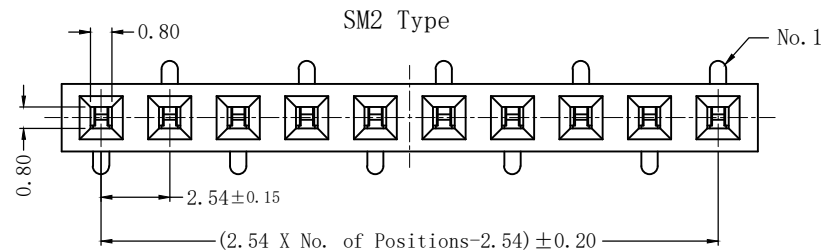
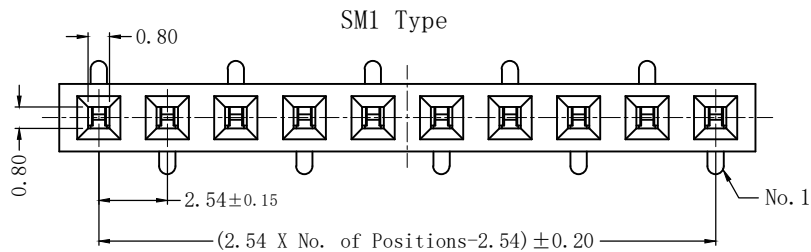
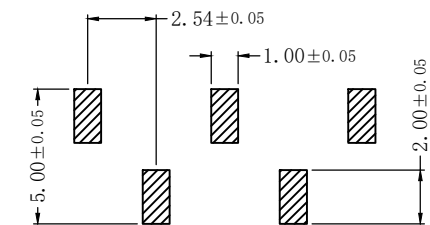


版次	变更内容	审核	日期



Recommended PCB Layout SM1 TYPE



Recommended PCB Layout SM2 TYPE

弯曲度: 1*02P ~ 1*20P 0.30 MAX.
 1*21P ~ 1*30P 0.40 MAX.
 1*31P ~ 1*40P 0.50 MAX.

技术参数: SPECIFICATIONS

额定电流 (Current Rating): 3A
 绝缘电阻 (Insulation Resistance): 1000MΩ Min.
 接触电阻 (Contact Resistance): 20mΩ Max.
 额定电压 (Dielectric Withstanding Voltage): AC 500V
 工作温度 (Operating Temperature): -40°C ~ +105°C
 最大加工温度 (Max Processing Temp): (230°C for 30~60 seconds)
 (260°C for 10 seconds)

接触材料 (Contact Material): 磷青铜 (Phosphor Bronze), THICKNESS 0.40mm
 塑胶材料 (Insulator Material): 尼龙 (Nylon)-9T, UL 94V-0, 颜色: 黑色
 接触电镀 (Contact Plating): 镀金 (Gold plated)
 (电镀规格可根据客户要求来定制)
 Opitonal planting on request.

203 SM_x-3C-1*_{xx}P G-A
 贴板类型: SM1: 第1Pin脚位朝下, SM2: 第1Pin脚位朝上
 单排芯数: 01~40P
 塑高: 7.1: 7.10mm
 电镀: G: 镀金Gold Flash, 1G: 镀金1u", 3G: 镀金3u" (镀金可订制)

公差:	版次:	A	上海宗进电子科技有限公司 Shanghai Zong Jin Electron Technology Co.LTD			
. X ±0.35	比例:		型号:	203SM _x -3C-1* _{xx} PG-A	签名	日期
. XX ±0.25	单位:	mm	描述:	2.54单排贴板排母	绘图:	
. XXX ±2°	页码:	1/1	图号:		确认:	
L NGLB					审核:	